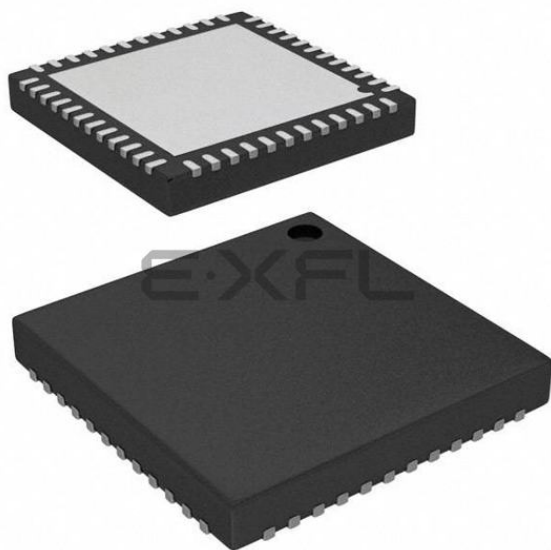




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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	M8C
Core Size	8-Bit
Speed	24MHz
Connectivity	I ² C, IrDA, SPI, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	44
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.25V
Data Converters	A/D 4x14b; D/A 4x9b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-VFQFN Exposed Pad
Supplier Device Package	48-QFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c28645-24ltxi

More Information

Cypress provides a wealth of data at www.cypress.com to help you to select the right PSoC device for your design, and to help you to quickly and effectively integrate the device into your design. For a comprehensive list of resources, see the knowledge base article “How to Design with PSoC® 1, PowerPSoC®, and PLC – KBA88292”. Following is an abbreviated list for PSoC 1:

- Overview: PSoC Portfolio, PSoC Roadmap
- Product Selectors: [PSoC 1](#), [PSoC 3](#), [PSoC 4](#), [PSoC 5LP](#)
- In addition, PSoC Designer includes a device selection tool.
- Application notes: Cypress offers a large number of PSoC application notes covering a broad range of topics, from basic to advanced level. Recommended application notes for getting started with PSoC 1 are:
 - [Getting Started with PSoC® 1 – AN75320](#)
 - [PSoC® 1 - Getting Started with GPIO – AN2094](#)
 - [PSoC® 1 Analog Structure and Configuration – AN74170](#)
 - [PSoC® 1 Switched Capacitor Analog Blocks – AN2041](#)
 - [Selecting Analog Ground and Reference – AN2219](#)

Note: For CY8C28xxx devices related Application note please click [here](#).

- Development Kits:
 - [CY3210-PSocEval1](#) supports all PSoC 1 Mixed-Signal Array families, including automotive, except CY8C25/26xxx devices. The kit includes an LCD module, potentiometer, LEDs, and breadboarding space.
 - [CY3214-PSocEvalUSB](#) features a development board for the CY8C24x94 PSoC device. Special features of the board include USB and CapSense development and debugging support.

Note: For CY8C28xxx devices related Development Kits please click [here](#).

The [MiniProg1](#) and [MiniProg3](#) devices provide interfaces for flash programming and debug.

PSoC Designer

[PSoC Designer](#) is a free Windows-based Integrated Design Environment (IDE). Develop your applications using a library of pre-characterized analog and digital peripherals in a drag-and-drop design environment. Then, customize your design leveraging the dynamically generated API libraries of code. [Figure 1](#) shows PSoC Designer windows. **Note:** This is not the default view.

1. **Global Resources** – all device hardware settings.
2. **Parameters** – the parameters of the currently selected User Modules.
3. **Pinout** – information related to device pins.
4. **Chip-Level Editor** – a diagram of the resources available on the selected chip.
5. **Datasheet** – the datasheet for the currently selected UM
6. **User Modules** – all available User Modules for the selected device.
7. **Device Resource Meter** – device resource usage for the current project configuration.
8. **Workspace** – a tree level diagram of files associated with the project.
9. **Output** – output from project build and debug operations.

Note: For detailed information on PSoC Designer, go to PSoC® Designer > Help > Documentation > Designer Specific Documents > IDE User Guide.

Figure 1. PSoC Designer Layout

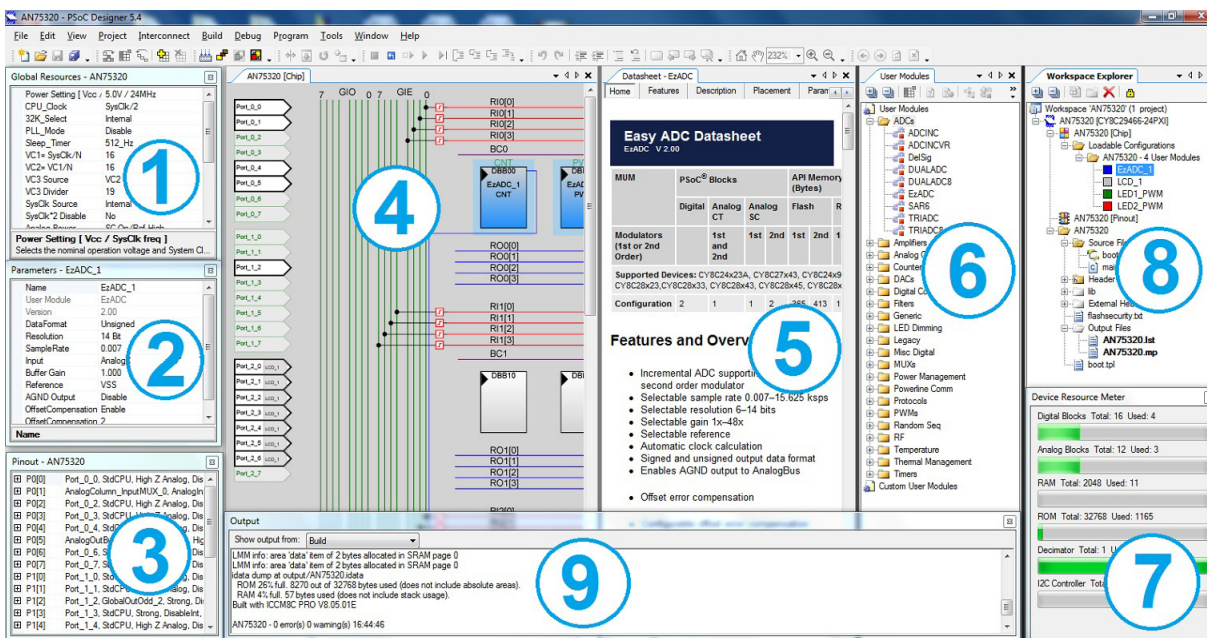


Figure 4. Analog System Block Diagram for CY8C28x43 Devices

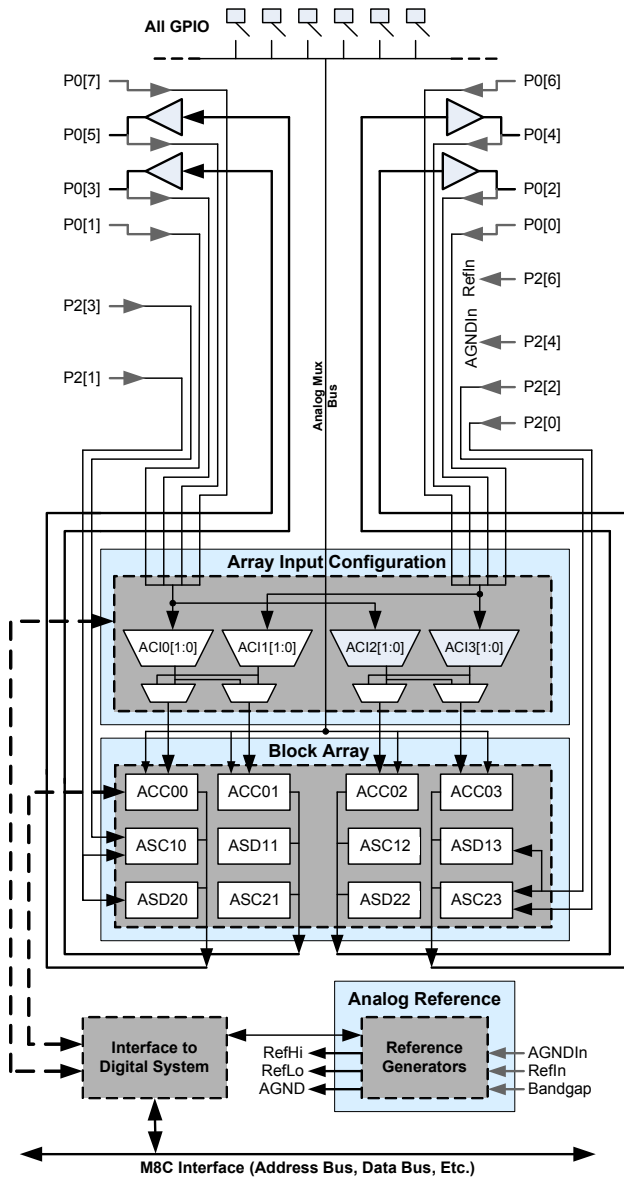
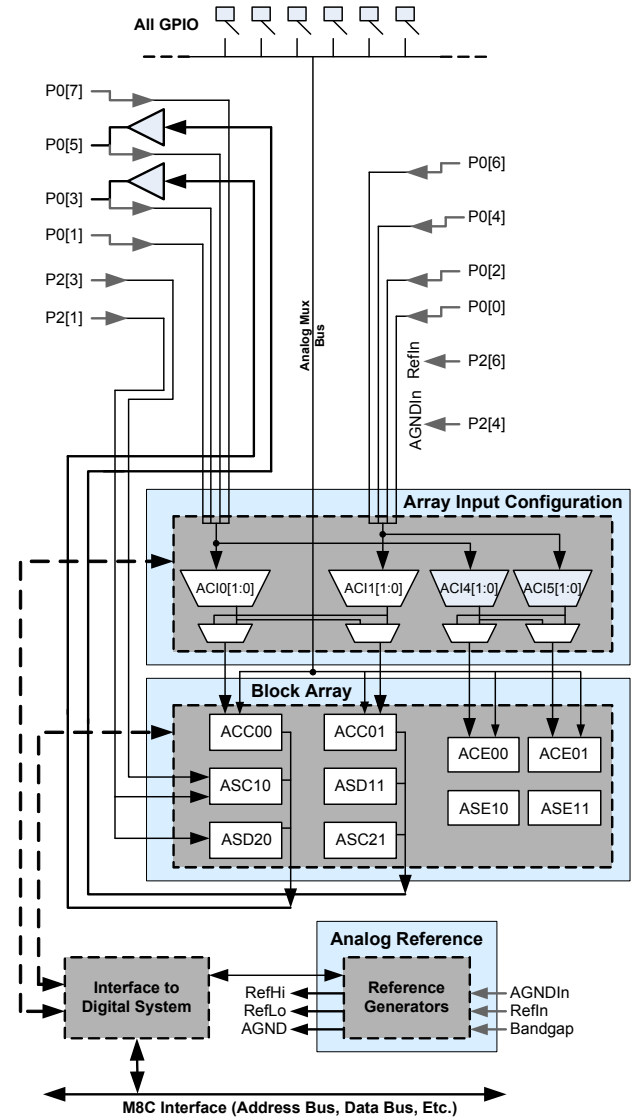


Figure 5. Analog System Block Diagram for CY8C28x33 Devices



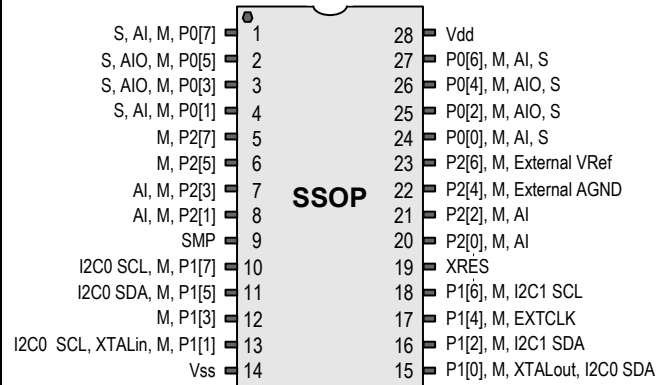
28-pin Part Pinout

Table 4. 28-pin Part Pinout (SSOP)

Pin No.	Type		Pin Name	Description
	Digital	Analog		
1	I/O	I, M, S	P0[7]	Analog column mux and SAR ADC input. ^[5]
2	I/O	I/O, M, S	P0[5]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]
3	I/O	I/O, M, S	P0[3]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]
4	I/O	I, M, S	P0[1]	Analog column mux and SAR ADC input. ^[5]
5	I/O	M	P2[7]	
6	I/O	M	P2[5]	
7	I/O	I, M	P2[3]	Direct switched capacitor block input. ^[9]
8	I/O	I, M	P2[1]	Direct switched capacitor block input. ^[9]
9	Output		SMP	Switch Mode Pump (SMP) connection to external components.
10	I/O	M	P1[7]	I2C0 Serial Clock (SCL).
11	I/O	M	P1[5]	I2C0 Serial Data (SDA).
12	I/O	M	P1[3]	
13	I/O	M	P1[1]	Crystal Input (XTALin), I2C0 Serial Clock (SCL), ISSP-SCLK ^[4] .
14	Power		V _{SS}	Ground connection.
15	I/O	M	P1[0]	Crystal Output (XTALout), I2C0 Serial Data (SDA), ISSP-SDATA ^[4] .
16	I/O	M	P1[2]	I2C1 Serial Data (SDA). ^[7]
17	I/O	M	P1[4]	Optional External Clock Input (EXTCLK).
18	I/O	M	P1[6]	I2C1 Serial Clock (SCL). ^[7]
19	Input		XRES	Active high external reset with internal pull-down.
20	I/O	I, M	P2[0]	Direct switched capacitor block input. ^[10]
21	I/O	I, M	P2[2]	Direct switched capacitor block input. ^[10]
22	I/O	M	P2[4]	External Analog Ground (AGND).
23	I/O	M	P2[6]	External Voltage Reference (VRef).
24	I/O	I, M, S	P0[0]	Analog column mux and SAR ADC input. ^[5]
25	I/O	I/O, M, S	P0[2]	Analog column mux and SAR ADC input. Analog column output. ^[5, 8]
26	I/O	I/O, M, S	P0[4]	Analog column mux and SAR ADC input. Analog column output. ^[5, 8]
27	I/O	I, M, S	P0[6]	Analog column mux and SAR ADC input. ^[5]
28	Power		V _{DD}	Supply voltage.

LEGEND: A = Analog, I = Input, O = Output, S = SAR ADC Input, and M = Analog Mux Bus Input

CY8C28403, CY8C28413, CY8C28433, CY8C28445, and CY8C28452 28-pin PSoc Devices



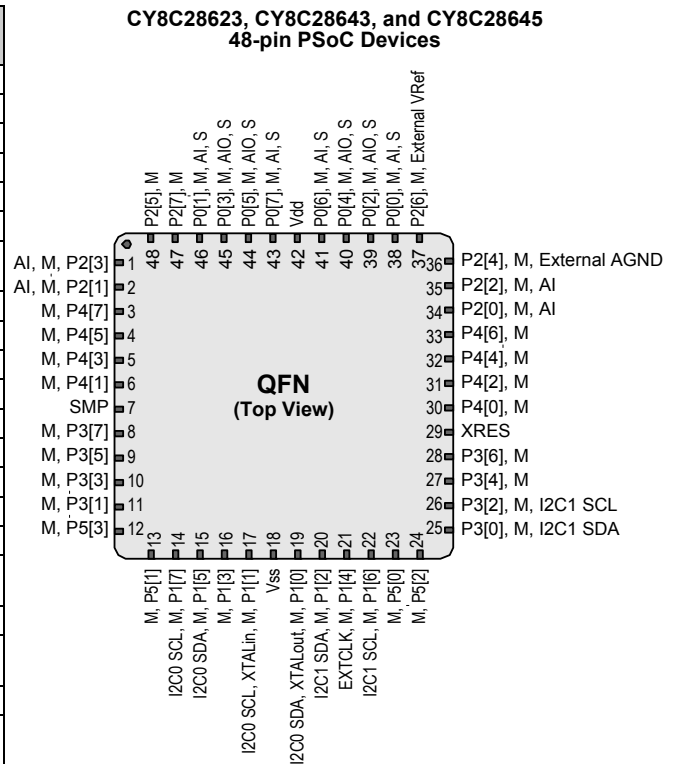
Notes

- This pin is not a direct switched capacitor block analog input for CY8C28x03 and CY8C28x13 devices.
- This pin is not a direct switched capacitor block analog input for CY8C28x03, CY8C28x13, CY8C28x23, and CY8C28x33 devices.

48-pin Part Pinout

Table 6. 48-pin Part Pinout (QFN^[11])

Pin No.	Type		Pin Name	Description
	Digital	Analog		
1	I/O	I, M	P2[3]	Direct switched capacitor block input. ^[9]
2	I/O	I, M	P2[1]	Direct switched capacitor block input. ^[9]
3	I/O	M	P4[7]	
4	I/O	M	P4[5]	
5	I/O	M	P4[3]	
6	I/O	M	P4[1]	
7	Output		SMP	Switch Mode Pump (SMP) connection to external components.
8	I/O	M	P3[7]	
9	I/O	M	P3[5]	
10	I/O	M	P3[3]	
11	I/O	M	P3[1]	
12	I/O	M	P5[3]	
13	I/O	M	P5[1]	
14	I/O	M	P1[7]	I2C0 Serial Clock (SCL).
15	I/O	M	P1[5]	I2C0 Serial Data (SDA).
16	I/O	M	P1[3]	
17	I/O	M	P1[1]	Crystal Input (XTALin), I2C0 Serial Clock (SCL), ISSP-SCLK ^[4] .
18	Power		V _{SS}	Ground connection.
19	I/O	M	P1[0]	Crystal Output (XTALout), I2C0 Serial Data (SDA), ISSP-SDATA ^[4] .
20	I/O	M	P1[2]	I2C1 Serial Data (SDA). ^[1]
21	I/O	M	P1[4]	Optional External Clock Input (EXTCLK).
22	I/O	M	P1[6]	I2C1 Serial Clock (SCL). ^[1]
23	I/O	M	P5[0]	
24	I/O	M	P5[2]	
25	I/O	M	P3[0]	I2C1 Serial Data (SDA). ^[1]
26	I/O	M	P3[2]	I2C1 Serial Clock (SCL). ^[1]
27	I/O	M	P3[4]	
28	I/O	M	P3[6]	
29	Input		XRES	Active high external reset with internal pull-down.
30	I/O	M	P4[0]	
31	I/O	M	P4[2]	
32	I/O	M	P4[4]	
33	I/O	M	P4[6]	
34	I/O	I, M	P2[0]	Direct switched capacitor block input. ^[10]
35	I/O	I, M	P2[2]	Direct switched capacitor block input. ^[10]
36	I/O	M	P2[4]	External Analog Ground (AGND).
37	I/O	M	P2[6]	External Voltage Reference (VRef).
38	I/O	I, M, S	P0[0]	Analog column mux and SAR ADC input. ^[5]
39	I/O	I/O, M, S	P0[2]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]
40	I/O	I/O, M, S	P0[4]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]



Pin No.	Type		Pin Name	Description
	Digital	Analog		
41	I/O	I, M, S	P0[6]	Analog column mux and SAR ADC input. ^[5]
42	Power		V _{DD}	Supply voltage.
43	I/O	I, M, S	P0[7]	Analog column mux and SAR ADC input. ^[5]
44	I/O	I/O, M, S	P0[5]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]
45	I/O	I/O, M, S	P0[3]	Analog column mux and SAR ADC input. Analog column output. ^[5, 6]
46	I/O	I, M, S	P0[1]	Analog column mux and SAR ADC input. ^[5]
47	I/O	M	P2[7]	
48	I/O	M	P2[5]	

LEGEND: A = Analog, I = Input, O = Output, S = SAR ADC Input, and M = Analog Mux Bus Input.

Note

11. The QFN package has a center pad that must be connected to ground (V_{SS}).

Table 14. CY8C28x33 Register Map Bank 0 Table: User Space

Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access
PRT0DR	00	RW	DBC20DR0	40	#	ASC10CR0	80	RW	RD12RI	C0	RW
PRT0IE	01	RW	DBC20DR1	41	W	ASC10CR1	81	RW	RD12SYN	C1	RW
PRT0GS	02	RW	DBC20DR2	42	RW	ASC10CR2	82	RW	RD12IS	C2	RW
PRT0DM2	03	RW	DBC20CR0	43	#	ASC10CR3	83	RW	RD12LT0	C3	RW
PRT1DR	04	RW	DBC21DR0	44	#	ASD11CR0	84	RW	RD12LT1	C4	RW
PRT1IE	05	RW	DBC21DR1	45	W	ASD11CR1	85	RW	RD12RO0	C5	RW
PRT1GS	06	RW	DBC21DR2	46	RW	ASD11CR2	86	RW	RD12RO1	C6	RW
PRT1DM2	07	RW	DBC21CR0	47	#	ASD11CR3	87	RW	RD12DSM	C7	RW
PRT2DR	08	RW	DCC22DR0	48	#		88			C8	
PRT2IE	09	RW	DCC22DR1	49	W		89			C9	
PRT2GS	0A	RW	DCC22DR2	4A	RW		8A			CA	
PRT2DM2	0B	RW	DCC22CR0	4B	#		8B			CB	
PRT3DR	0C	RW	DCC23DR0	4C	#		8C			CC	
PRT3IE	0D	RW	DCC23DR1	4D	W		8D			CD	
PRT3GS	0E	RW	DCC23DR2	4E	RW		8E			CE	
PRT3DM2	0F	RW	DCC23CR0	4F	#		8F			CF	
PRT4DR	10	RW		50		ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4IE	11	RW		51		ASD20CR1	91	RW	STK_PP	D1	RW
PRT4GS	12	RW		52		ASD20CR2	92	RW		D2	
PRT4DM2	13	RW		53		ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5DR	14	RW		54		ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5IE	15	RW		55		ASC21CR1	95	RW	MVW_PP	D5	RW
PRT5GS	16	RW		56		ASC21CR2	96	RW	I2C0_CFG	D6	RW
PRT5DM2	17	RW		57		ASC21CR3	97	RW	I2C0_SCR	D7	#
	18			58			98		I2C0_DR	D8	RW
	19			59			99		I2C0_MSCR	D9	#
	1A			5A			9A		INT_CLR0	DA	RW
	1B			5B			9B		INT_CLR1	DB	RW
	1C			5C			9C		INT_CLR2	DC	RW
	1D			5D			9D		INT_CLR3	DD	RW
	1E			5E			9E		INT_MSK3	DE	RW
	1F			5F			9F		INT_MSK2	DF	RW
DBC00DR0	20	#	AMX_IN	60	RW	DEC0_DH	A0	RC	INT_MSK0	E0	RW
DBC00DR1	21	W	AMUX_CFG	61	RW	DEC0_DL	A1	RC	INT_MSK1	E1	RW
DBC00DR2	22	RW	CLK_CR3	62	RW	DEC1_DH	A2	RC	INT_VC	E2	RC
DBC00CR0	23	#	ARF_CR	63	RW	DEC1_DL	A3	RC	RES_WDT	E3	W
DBC01DR0	24	#	CMP_CR0	64	#	DEC2_DH	A4	RC		E4	
DBC01DR1	25	W	ASY_CR	65	#	DEC2_DL	A5	RC		E5	
DBC01DR2	26	RW	CMP_CR1	66	RW	DEC3_DH	A6	RC	DEC_CR0*	E6	RW
DBC01CR0	27	#		67		DEC3_DL	A7	RC	DEC_CR1*	E7	RW
DCC02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCC02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCC02DR2	2A	RW	SADC_DH	6A	RW	MUL1_DH	AA	R	MUL0_DH	EA	R
DCC02CR0	2B	#	SADC_DL	6B	RW	MUL1_DL	AB	R	MUL0_DL	EB	R
DCC03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCC03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCC03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCC03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBC10DR0	30	#	ACB00CR3	70	RW	RD10RI	B0	RW		F0	
DBC10DR1	31	W	ACB00CR0	71	RW	RD10SYN	B1	RW		F1	
DBC10DR2	32	RW	ACB00CR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR0	33	#	ACB00CR2	73	RW	RD10LT0	B3	RW		F3	
DBC11DR0	34	#	ACB01CR3	74	RW	RD10LT1	B4	RW		F4	
DBC11DR1	35	W	ACB01CR0	75	RW	RD10RO0	B5	RW		F5	
DBC11DR2	36	RW	ACB01CR1	76	RW	RD10RO1	B6	RW		F6	
DBC11CR0	37	#	ACB01CR2	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12DR0	38	#		78		RD11RI	B8	RW		F8	
DCC12DR1	39	W		79		RD11SYN	B9	RW		F9	
DCC12DR2	3A	RW		7A		RD11IS	BA	RW		FA	
DCC12CR0	3B	#		7B		RD11LT0	BB	RW		FB	
DCC13DR0	3C	#		7C		RD11LT1	BC	RW	DAC1_D	FC	RW
DCC13DR1	3D	W		7D		RD11RO0	BD	RW	DAC0_D	FD	RW
DCC13DR2	3E	RW		7E		RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR0	3F	#		7F		RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 15. CY8C28x33 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80		RD12RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW	SADC_TSCMPL	81	RW	RD12SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW	SADC_TSCMPH	82	RW	RD12IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW	ACE_AMD_CR1	83	RW	RD12LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84		RD12LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW	ACE_PWM_CR	85	RW	RD12RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW	ACE_ADC0_CR	86	RW	RD12RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW	ACE_ADC1_CR	87	RW	RD12DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88	RW		C8	
PRT2DM1	09	RW	DCC22IN	49	RW	ACE_CLK_CR0	89	RW		C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW	ACE_CLK_CR1	8A	RW		CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW	ACE_CLK_CR3	8B	RW		CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C			CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW	ACE01CR1	8D	RW		CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW	ACE01CR2	8E	RW		CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW	ASE11CR0	8F	RW		CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94		DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56		DEC_CR4	96	RW	DEC2_CR	D6	RW
PRT5IC1	17	RW		57			97		DEC3_CR	D7	RW
	18			58			98		MUX_CR0	D8	RW
	19			59		DEC2_CR0	99	RW	MUX_CR1	D9	RW
	1A			5A		DEC_CR5	9A	RW	MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
	1C			5C			9C		IDAC_CR1	DC	RW
	1D			5D		DEC3_CR0	9D	RW	OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW	CLK_CR0	60	RW	GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW	CLK_CR1	61	RW	GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW	ABF_CR0	62	RW	GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW	AMD_CR0	63	RW	GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW	CMP_GO_EN	64	RW	RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW		65		RTC_M	A5	RW	ADC0_TR	E5	RW
DBC01OU	26	RW	AMD_CR1	66	RW	RTC_S	A6	RW	ADC1_TR	E6	RW
DBC01CR1	27	RW	ALT_CR0	67	RW	RTC_CR	A7	RW	IDAC_CR2	E7	RW
DCC02FN	28	RW		68		SADC_CR0	A8	RW	IMO_TR	E8	RW
DCC02IN	29	RW	CLK_CR2	69	RW	SADC_CR1	A9	RW	ILO_TR	E9	RW
DCC02OU	2A	RW	AMUX_CFG1	6A	RW	SADC_CR2	AA	RW	BDG_TR	EA	RW
DCC02CR1	2B	RW		6B		SADC_CR3	AB	RW	ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW	SADC_CR4	AC	RW	MUX_CR4	EC	RW
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW	MUX_CR5	ED	RW
DCC03OU	2E	RW	TMP_DR2	6E	RW		AE			EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RD10RI	B0	RW		F0	
DBC10IN	31	RW	SADC_TSCR0	71	RW	RD10SYN	B1	RW		F1	
DBC10OU	32	RW	SADC_TSCR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR1	33	RW	ACE_AMD_CR0	73	RW	RD10LT0	B3	RW		F3	
DBC11FN	34	RW		74		RD10LT1	B4	RW		F4	
DBC11IN	35	RW	ACE_AMX_IN	75	RW	RD10RO0	B5	RW		F5	
DBC11OU	36	RW	ACE_CMP_CR0	76	RW	RD10RO1	B6	RW		F6	
DBC11CR1	37	RW	ACE_CMP_CR1	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RD11RI	B8	RW		F8	
DCC12IN	39	RW	ACE_CMP_GI_EN	79	RW	RD11SYN	B9	RW		F9	
DCC12OU	3A	RW	ACE_ALT_CR0	7A	RW	RD11IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW	ACE_ABF_CR0	7B	RW	RD11LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RD11LT1	BC	RW		FC	
DCC13IN	3D	RW	ACE0_CR1	7D	RW	RD11RO0	BD	RW	IDAC_CR0	FD	RW
DCC13OU	3E	RW	ACE0_CR2	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW	ACE0_CR3	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 16. CY8C28x43 Register Map Bank 0 Table: User Space

Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access
PRT0DR	00	RW	DBC20DR0	40	#	ASC10CR0	80	RW	RD12RI	C0	RW
PRT0IE	01	RW	DBC20DR1	41	W	ASC10CR1	81	RW	RD12SYN	C1	RW
PRT0GS	02	RW	DBC20DR2	42	RW	ASC10CR2	82	RW	RD12IS	C2	RW
PRT0DM2	03	RW	DBC20CR0	43	#	ASC10CR3	83	RW	RD12LT0	C3	RW
PRT1DR	04	RW	DBC21DR0	44	#	ASD11CR0	84	RW	RD12LT1	C4	RW
PRT1IE	05	RW	DBC21DR1	45	W	ASD11CR1	85	RW	RD12RO0	C5	RW
PRT1GS	06	RW	DBC21DR2	46	RW	ASD11CR2	86	RW	RD12RO1	C6	RW
PRT1DM2	07	RW	DBC21CR0	47	#	ASD11CR3	87	RW	RD12DSM	C7	RW
PRT2DR	08	RW	DCC22DR0	48	#	ASC12CR0	88	RW		C8	
PRT2IE	09	RW	DCC22DR1	49	W	ASC12CR1	89	RW		C9	
PRT2GS	0A	RW	DCC22DR2	4A	RW	ASC12CR2	8A	RW		CA	
PRT2DM2	0B	RW	DCC22CR0	4B	#	ASC12CR3	8B	RW		CB	
PRT3DR	0C	RW	DCC23DR0	4C	#	ASD13CR0	8C	RW		CC	
PRT3IE	0D	RW	DCC23DR1	4D	W	ASD13CR1	8D	RW		CD	
PRT3GS	0E	RW	DCC23DR2	4E	RW	ASD13CR2	8E	RW		CE	
PRT3DM2	0F	RW	DCC23CR0	4F	#	ASD13CR3	8F	RW		CF	
PRT4DR	10	RW		50		ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4IE	11	RW		51		ASD20CR1	91	RW	STK_PP	D1	RW
PRT4GS	12	RW		52		ASD20CR2	92	RW		D2	
PRT4DM2	13	RW		53		ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5DR	14	RW		54		ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5IE	15	RW		55		ASC21CR1	95	RW	MVW_PP	D5	RW
PRT5GS	16	RW		56		ASC21CR2	96	RW	I2C0_CFG	D6	RW
PRT5DM2	17	RW		57		ASC21CR3	97	RW	I2C0_SCR	D7	#
	18			58		ASD22CR0	98	RW	I2C0_DR	D8	RW
	19			59		ASD22CR1	99	RW	I2C0_MSCR	D9	#
	1A			5A		ASD22CR2	9A	RW	INT_CLR0	DA	RW
	1B			5B		ASD22CR3	9B	RW	INT_CLR1	DB	RW
	1C			5C		ASC23CR0	9C	RW	INT_CLR2	DC	RW
	1D			5D		ASC23CR1	9D	RW	INT_CLR3	DD	RW
	1E			5E		ASC23CR2	9E	RW	INT_MSK3	DE	RW
	1F			5F		ASC23CR3	9F	RW	INT_MSK2	DF	RW
DBC00DR0	20	#	AMX_IN	60	RW	DEC0_DH	A0	RC	INT_MSK0	E0	RW
DBC00DR1	21	W	AMUX_CFG	61	RW	DEC0_DL	A1	RC	INT_MSK1	E1	RW
DBC00DR2	22	RW	CLK_CR3	62	RW	DEC1_DH	A2	RC	INT_VC	E2	RC
DBC00CR0	23	#	ARF_CR	63	RW	DEC1_DL	A3	RC	RES_WDT	E3	W
DBC01DR0	24	#	CMP_CR0	64	#	DEC2_DH	A4	RC	I2C1_SCR	E4	#
DBC01DR1	25	W	ASY_CR	65	#	DEC2_DL	A5	RC	I2C1_MSCR	E5	#
DBC01DR2	26	RW	CMP_CR1	66	RW	DEC3_DH	A6	RC	DEC_CR0*	E6	RW
DBC01CR0	27	#	I2C1_DR	67	RW	DEC3_DL	A7	RC	DEC_CR1*	E7	RW
DCC02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCC02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCC02DR2	2A	RW	SADC_DH	6A	RW	MUL1_DH	AA	R	MUL0_DH	EA	R
DCC02CR0	2B	#	SADC_DL	6B	RW	MUL1_DL	AB	R	MUL0_DL	EB	R
DCC03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCC03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCC03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCC03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBC10DR0	30	#	ACB00CR3	70	RW	RD10RI	B0	RW		F0	
DBC10DR1	31	W	ACB00CR0	71	RW	RD10SYN	B1	RW		F1	
DBC10DR2	32	RW	ACB00CR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR0	33	#	ACB00CR2	73	RW	RD10LT0	B3	RW		F3	
DBC11DR0	34	#	ACB01CR3	74	RW	RD10LT1	B4	RW		F4	
DBC11DR1	35	W	ACB01CR0	75	RW	RD10RO0	B5	RW		F5	
DBC11DR2	36	RW	ACB01CR1	76	RW	RD10RO1	B6	RW		F6	
DBC11CR0	37	#	ACB01CR2	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12DR0	38	#	ACB02CR3	78	RW	RD11RI	B8	RW		F8	
DCC12DR1	39	W	ACB02CR0	79	RW	RD11SYN	B9	RW		F9	
DCC12DR2	3A	RW	ACB02CR1	7A	RW	RD11IS	BA	RW		FA	
DCC12CR0	3B	#	ACB02CR2	7B	RW	RD11LT0	BB	RW		FB	
DCC13DR0	3C	#	ACB03CR3	7C	RW	RD11LT1	BC	RW		FC	
DCC13DR1	3D	W	ACB03CR0	7D	RW	RD11RO0	BD	RW		FD	
DCC13DR2	3E	RW	ACB03CR1	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR0	3F	#	ACB03CR2	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 19. CY8C28x45 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80	RW	RD12RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW	SADC_TSCMPL	81	RW	RD12SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW	SADC_TSCMPH	82	RW	RD12IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW	ACE_AMD_CR1	83	RW	RD12LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84	RW	RD12LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW	ACE_PWM_CR	85	RW	RD12RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW	ACE_ADC0_CR	86	RW	RD12RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW	ACE_ADC1_CR	87	RW	RD12DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88	RW		C8	
PRT2DM1	09	RW	DCC22IN	49	RW	ACE_CLK_CR0	89	RW		C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW	ACE_CLK_CR1	8A	RW		CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW	ACE_CLK_CR3	8B	RW		CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C	RW		CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW	ACE01CR1	8D	RW		CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW	ACE01CR2	8E	RW		CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW	ASE11CR0	8F	RW		CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94		DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56		DEC_CR4	96	RW	DEC2_CR	D6	RW
PRT5IC1	17	RW		57			97		DEC3_CR	D7	RW
	18			58			98		MUX_CR0	D8	RW
	19			59		DEC2_CR0	99	RW	MUX_CR1	D9	RW
	1A			5A		DEC_CR5	9A	RW	MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
	1C			5C			9C		IDAC_CR1	DC	RW
	1D			5D		DEC3_CR0	9D	RW	OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW	CLK_CR0	60	RW	GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW	CLK_CR1	61	RW	GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW	ABF_CR0	62	RW	GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW	AMD_CR0	63	RW	GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW	CMP_GO_EN	64	RW	RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW	CMP_GO_EN1	65	RW	RTC_M	A5	RW	ADC0_TR	E5	RW
DBC01OU	26	RW	AMD_CR1	66	RW	RTC_S	A6	RW	ADC1_TR	E6	RW
DBC01CR1	27	RW	ALT_CR0	67	RW	RTC_CR	A7	RW	IDAC_CR2	E7	RW
DCC02FN	28	RW	ALT_CR1	68	RW	SADC_CR0	A8	RW	IMO_TR	E8	RW
DCC02IN	29	RW	CLK_CR2	69	RW	SADC_CR1	A9	RW	ILO_TR	E9	RW
DCC02OU	2A	RW	AMUX_CFG1	6A	RW	SADC_CR2	AA	RW	BDG_TR	EA	RW
DCC02CR1	2B	RW	I2C1_CFG	6B	RW	SADC_CR3	AB	RW	ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW	SADC_CR4	AC	RW	MUX_CR4	EC	RW
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW	MUX_CR5	ED	RW
DCC03OU	2E	RW	TMP_DR2	6E	RW	I2C1_ADDR	AE	RW		EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RD10RI	B0	RW		F0	
DBC10IN	31	RW	SADC_TSCR0	71	RW	RD10SYN	B1	RW		F1	
DBC10OU	32	RW	SADC_TSCR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR1	33	RW	ACE_AMD_CR0	73	RW	RD10LT0	B3	RW		F3	
DBC11FN	34	RW		74		RD10LT1	B4	RW		F4	
DBC11IN	35	RW	ACE_AMX_IN	75	RW	RD10RO0	B5	RW		F5	
DBC11OU	36	RW	ACE_CMP_CR0	76	RW	RD10RO1	B6	RW		F6	
DBC11CR1	37	RW	ACE_CMP_CR1	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RD11RI	B8	RW		F8	
DCC12IN	39	RW	ACE_CMP_GI_EN	79	RW	RD11SYN	B9	RW		F9	
DCC12OU	3A	RW	ACE_ALT_CR0	7A	RW	RD11IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW	ACE_ABF_CR0	7B	RW	RD11LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RD11LT1	BC	RW		FC	
DCC13IN	3D	RW	ACE0_CR1	7D	RW	RD11RO0	BD	RW	IDAC_CR0	FD	RW
DCC13OU	3E	RW	ACE0_CR2	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW	ACE0_CR3	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 20. CY8C28x52 Register Map Bank 0 Table: User Space

Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access	Name	Addr (0,Hex)	Access
PRT0DR	00	RW		40		ASC10CR0	80	RW		C0	
PRT0IE	01	RW		41		ASC10CR1	81	RW		C1	
PRT0GS	02	RW		42		ASC10CR2	82	RW		C2	
PRT0DM2	03	RW		43		ASC10CR3	83	RW		C3	
PRT1DR	04	RW		44		ASD11CR0	84	RW		C4	
PRT1IE	05	RW		45		ASD11CR1	85	RW		C5	
PRT1GS	06	RW		46		ASD11CR2	86	RW		C6	
PRT1DM2	07	RW		47		ASD11CR3	87	RW		C7	
PRT2DR	08	RW		48		ASC12CR0	88	RW		C8	
PRT2IE	09	RW		49		ASC12CR1	89	RW		C9	
PRT2GS	0A	RW		4A		ASC12CR2	8A	RW		CA	
PRT2DM2	0B	RW		4B		ASC12CR3	8B	RW		CB	
PRT3DR	0C	RW		4C		ASD13CR0	8C	RW		CC	
PRT3IE	0D	RW		4D		ASD13CR1	8D	RW		CD	
PRT3GS	0E	RW		4E		ASD13CR2	8E	RW		CE	
PRT3DM2	0F	RW		4F		ASD13CR3	8F	RW		CF	
PRT4DR	10	RW		50		ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4IE	11	RW		51		ASD20CR1	91	RW	STK_PP	D1	RW
PRT4GS	12	RW		52		ASD20CR2	92	RW		D2	
PRT4DM2	13	RW		53		ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5DR	14	RW		54		ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5IE	15	RW		55		ASC21CR1	95	RW	MVW_PP	D5	RW
PRT5GS	16	RW		56		ASC21CR2	96	RW	I2C0_CFG	D6	RW
PRT5DM2	17	RW		57		ASC21CR3	97	RW	I2C0_SCR	D7	#
	18			58		ASD22CR0	98	RW	I2C0_DR	D8	RW
	19			59		ASD22CR1	99	RW	I2C0_MSCR	D9	#
	1A			5A		ASD22CR2	9A	RW	INT_CLR0	DA	RW
	1B			5B		ASD22CR3	9B	RW	INT_CLR1	DB	RW
	1C			5C		ASC23CR0	9C	RW	INT_CLR2	DC	RW
	1D			5D		ASC23CR1	9D	RW	INT_CLR3	DD	RW
	1E			5E		ASC23CR2	9E	RW	INT_MSK3	DE	RW
	1F			5F		ASC23CR3	9F	RW	INT_MSK2	DF	RW
DBC00DR0	20	#	AMX_IN	60	RW	DEC0_DH	A0	RC	INT_MSK0	E0	RW
DBC00DR1	21	W	AMUX_CFG	61	RW	DEC0_DL	A1	RC	INT_MSK1	E1	RW
DBC00DR2	22	RW	CLK_CR3	62	RW	DEC1_DH	A2	RC	INT_VC	E2	RC
DBC00CR0	23	#	ARF_CR	63	RW	DEC1_DL	A3	RC	RES_WDT	E3	W
DBC01DR0	24	#	CMP_CR0	64	#	DEC2_DH	A4	RC		E4	
DBC01DR1	25	W	ASY_CR	65	#	DEC2_DL	A5	RC		E5	
DBC01DR2	26	RW	CMP_CR1	66	RW	DEC3_DH	A6	RC	DEC_CR0*	E6	RW
DBC01CR0	27	#		67		DEC3_DL	A7	RC	DEC_CR1*	E7	RW
DCC02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCC02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCC02DR2	2A	RW		6A		MUL1_DH	AA	R	MUL0_DH	EA	R
DCC02CR0	2B	#		6B		MUL1_DL	AB	R	MUL0_DL	EB	R
DCC03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCC03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCC03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCC03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBC10DR0	30	#	ACB00CR3	70	RW	RD10RI	B0	RW		F0	
DBC10DR1	31	W	ACB00CR0	71	RW	RD10SYN	B1	RW		F1	
DBC10DR2	32	RW	ACB00CR1	72	RW	RD10IS	B2	RW		F2	
DBC10CR0	33	#	ACB00CR2	73	RW	RD10LT0	B3	RW		F3	
DBC11DR0	34	#	ACB01CR3	74	RW	RD10LT1	B4	RW		F4	
DBC11DR1	35	W	ACB01CR0	75	RW	RD10RO0	B5	RW		F5	
DBC11DR2	36	RW	ACB01CR1	76	RW	RD10RO1	B6	RW		F6	
DBC11CR0	37	#	ACB01CR2	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12DR0	38	#	ACB02CR3	78	RW	RD11RI	B8	RW		F8	
DCC12DR1	39	W	ACB02CR0	79	RW	RD11SYN	B9	RW		F9	
DCC12DR2	3A	RW	ACB02CR1	7A	RW	RD11IS	BA	RW		FA	
DCC12CR0	3B	#	ACB02CR2	7B	RW	RD11LT0	BB	RW		FB	
DCC13DR0	3C	#	ACB03CR3	7C	RW	RD11LT1	BC	RW	DAC1_D	FC	RW
DCC13DR1	3D	W	ACB03CR0	7D	RW	RD11RO0	BD	RW	DAC0_D	FD	RW
DCC13DR2	3E	RW	ACB03CR1	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR0	3F	#	ACB03CR2	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

Table 21. CY8C28x52 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW		40			80			C0	
PRT0DM1	01	RW		41			81			C1	
PRT0IC0	02	RW		42			82			C2	
PRT0IC1	03	RW		43		ACE_AMD_CR1	83	RW		C3	
PRT1DM0	04	RW		44			84			C4	
PRT1DM1	05	RW		45		ACE_PWM_CR	85	RW		C5	
PRT1IC0	06	RW		46		ACE_ADC0_CR	86	RW		C6	
PRT1IC1	07	RW		47		ACE_ADC1_CR	87	RW		C7	
PRT2DM0	08	RW		48			88			C8	
PRT2DM1	09	RW		49		ACE_CLK_CR0	89	RW		C9	
PRT2IC0	0A	RW		4A		ACE_CLK_CR1	8A	RW		CA	
PRT2IC1	0B	RW		4B		ACE_CLK_CR3	8B	RW		CB	
PRT3DM0	0C	RW		4C			8C			CC	
PRT3DM1	0D	RW		4D		ACE01CR1	8D	RW		CD	
PRT3IC0	0E	RW		4E		ACE01CR2	8E	RW		CE	
PRT3IC1	0F	RW		4F		ASE11CR0	8F	RW		CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94		DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56		DEC_CR4	96	RW	DEC2_CR	D6	RW
PRT5IC1	17	RW		57			97		DEC3_CR	D7	RW
	18			58			98		MUX_CR0	D8	RW
	19			59		DEC2_CR0	99	RW	MUX_CR1	D9	RW
	1A			5A		DEC_CR5	9A	RW	MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
	1C			5C			9C		IDAC_CR1	DC	RW
	1D			5D		DEC3_CR0	9D	RW	OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW	CLK_CR0	60	RW	GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW	CLK_CR1	61	RW	GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW	ABF_CR0	62	RW	GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW	AMD_CR0	63	RW	GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW	CMP_GO_EN	64	RW	RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW	CMP_GO_EN1	65	RW	RTC_M	A5	RW	ADC0_TR	E5	RW
DBC01OU	26	RW	AMD_CR1	66	RW	RTC_S	A6	RW	ADC1_TR	E6	RW
DBC01CR1	27	RW	ALT_CR0	67	RW	RTC_CR	A7	RW	IDAC_CR2	E7	RW
DCC02FN	28	RW	ALT_CR1	68	RW		A8		IMO_TR	E8	RW
DCC02IN	29	RW	CLK_CR2	69	RW		A9		ILO_TR	E9	RW
DCC02OU	2A	RW	AMUX_CFG1	6A	RW		AA		BDG_TR	EA	RW
DCC02CR1	2B	RW		6B			AB		ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW		AC		MUX_CR4	EC	RW
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW	MUX_CR5	ED	RW
DCC03OU	2E	RW	TMP_DR2	6E	RW		AE			EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RD10RI	B0	RW		F0	
DBC10IN	31	RW		71		RD10SYN	B1	RW		F1	
DBC10OU	32	RW		72		RD10IS	B2	RW		F2	
DBC10CR1	33	RW	ACE_AMD_CR0	73	RW	RD10LT0	B3	RW		F3	
DBC11FN	34	RW		74		RD10LT1	B4	RW		F4	
DBC11IN	35	RW	ACE_AMX_IN	75	RW	RD10RO0	B5	RW		F5	
DBC11OU	36	RW	ACE_CMP_CR0	76	RW	RD10RO1	B6	RW		F6	
DBC11CR1	37	RW	ACE_CMP_CR1	77	RW	RD10DSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RD11RI	B8	RW		F8	
DCC12IN	39	RW	ACE_CMP_GI_EN	79	RW	RD11SYN	B9	RW		F9	
DCC12OU	3A	RW	ACE_ALT_CR0	7A	RW	RD11IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW	ACE_ABF_CR0	7B	RW	RD11LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RD11LT1	BC	RW		FC	
DCC13IN	3D	RW	ACE0_CR1	7D	RW	RD11RO0	BD	RW	IDAC_CR0	FD	RW
DCC13OU	3E	RW	ACE0_CR2	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW	ACE0_CR3	7F	RW	RD11DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

*Address has a dual purpose, see "Mapping Exceptions" on page 251

DC Electrical Characteristics

DC Chip Level Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 24. DC Chip Level Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{DD}	Supply voltage	3.00	–	5.25	V	
I_{DD}	Supply current	–	8	14	mA	Conditions are $V_{DD} = 5.0\text{ V}$, $T_A = 25^{\circ}\text{C}$, CPU = 3 MHz, SYSCLK doubler disabled. VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 93.75 kHz.
I_{DD3}	Supply current	–	5	9	mA	Conditions are $V_{DD} = 3.3\text{ V}$, $T_A = 25^{\circ}\text{C}$, CPU = 3 MHz, SYSCLK doubler disabled. VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 93.75 kHz.
I_{DDP}	Supply current when IMO = 6 MHz using SLIMO mode=1	–	2	3	mA	Conditions are $V_{DD} = 3.3\text{ V}$, $T_A = 25^{\circ}\text{C}$, CPU = 0.75 MHz, SYSCLK doubler disabled, VC1 = 0.375 MHz, VC2 = 23.44 kHz, VC3 = 0.09 kHz.
I_{SB}	Sleep (Mode) current with POR, LVD, sleep timer, and WDT. ^[12]	–	3	10	μA	Conditions are with internal slow speed oscillator, $V_{DD} = 3.3\text{ V}$, $-40^{\circ}\text{C} \leq T_A \leq 55^{\circ}\text{C}$.
I_{SBH}	Sleep (Mode) current with POR, LVD, sleep timer, and WDT at high temperature. ^[12]	–	4	25	μA	Conditions are with internal slow speed oscillator, $V_{DD} = 3.3\text{ V}$, $55^{\circ}\text{C} < T_A \leq 85^{\circ}\text{C}$.
I_{SBXTL}	Sleep (Mode) Current with POR, LVD, sleep timer, WDT, and external crystal. ^[12]	–	4	13	μA	Conditions are with properly loaded, 1 μW max, 32.768 kHz crystal. $V_{DD} = 3.3\text{ V}$, $-40^{\circ}\text{C} \leq T_A \leq 55^{\circ}\text{C}$.
I_{SBXTLH}	Sleep (Mode) current with POR, LVD, sleep timer, WDT, and external crystal at high temperature. ^[12]	–	5	26	μA	Conditions are with properly loaded, 1 μW max, 32.768 kHz crystal. $V_{DD} = 3.3\text{ V}$, $55^{\circ}\text{C} < T_A \leq 85^{\circ}\text{C}$.
I_{SBRTC}	Current consumed by RTC during sleep	–	0.5	1	μA	Extra current consumed by the RTC during sleep. This number is typical at 25°C and 5 V.
V_{REF}	Reference voltage (Bandgap)	1.280	1.300	1.320	V	Trimmed for appropriate V_{DD} .
I_{SXRES}	Supply current with XRES asserted 5 V	–	0.65	3	mA	Max is peak current after XRES;
	Supply current with XRES asserted 3.3 V	–	0.4	1.5	mA	Typical value is the steady state current value. $T_A = 25^{\circ}\text{C}$.

Note

12. Standby (sleep) current includes all functions (POR, LVD, WDT, Sleep Timer) needed for reliable system operation. This should be compared with devices that have similar functions enabled.

DC GPIO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 25. DC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
R_{PU}	Pull-up resistor	4	5.6	8	$k\Omega$	
R_{PD}	Pull-down resistor	4	5.6	8	$k\Omega$	
V_{OH}	High output level	$V_{DD} - 1.0$	—	—	V	$I_{OH} = 10\text{ mA}$, $V_{DD} = 4.75\text{ to }5.25\text{ V}$ (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 80 mA maximum combined I_{OH} budget.
V_{OL}	Low output level	—	—	0.75	V	$I_{OL} = 25\text{ mA}$, $V_{DD} = 4.75\text{ to }5.25\text{ V}$ (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 150 mA maximum combined I_{OL} budget.
I_{OH}	High level source current	10	—	—	mA	$V_{OH} = V_{DD} - 1.0\text{ V}$, see the limitations of the total current in the note for V_{OH} .
I_{OL}	Low level sink current	25	—	—	mA	$V_{OL} = 0.75\text{ V}$, see the limitations of the total current in the note for V_{OL} .
V_{IL}	Input low level	—	—	0.8	V	$V_{DD} = 3.0\text{ to }5.25$.
V_{IH}	Input high level	2.1	—	—	V	$V_{DD} = 3.0\text{ to }5.25$.
V_H	Input hysteresis	—	60	—	mV	
I_{IL}	Input leakage (absolute value)	—	1	—	nA	Gross tested to $1\text{ }\mu\text{A}$.
C_{IN}	Capacitive load on pins as input	—	3.5	10	pF	Package and pin dependent. Temp = 25°C .
C_{OUT}	Capacitive load on pins as output	—	3.5	10	pF	Package and pin dependent. Temp = 25°C .

Table 34. 5-V DC Analog Reference Specifications *(continued)*

Reference ARF_CR [5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Units
0b011	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	3 × Bandgap	3.736	3.887	4.030	V
		V _{AGND}	AGND	2 × Bandgap	2.525	2.598	2.667	V
		V _{REFLO}	Ref low	Bandgap	1.265	1.302	1.335	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	3 × Bandgap	3.747	3.894	4.034	V
		V _{AGND}	AGND	2 × Bandgap	2.528	2.601	2.668	V
		V _{REFLO}	Ref low	Bandgap	1.264	1.302	1.335	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	3 × Bandgap	3.749	3.897	4.035	V
		V _{AGND}	AGND	2 × Bandgap	2.529	2.602	2.668	V
		V _{REFLO}	Ref low	Bandgap	1.264	1.302	1.335	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	3 × Bandgap	3.751	3.899	4.037	V
		V _{AGND}	AGND	2 × Bandgap	2.530	2.603	2.669	V
		V _{REFLO}	Ref low	Bandgap	1.264	1.302	1.335	V
0b100	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap + P2[6] (P2[6] = 1.3 V)	2.483 – P2[6]	2.578 – P2[6]	2.669 – P2[6]	V
		V _{AGND}	AGND	2 × Bandgap	2.525	2.598	2.666	V
		V _{REFLO}	Ref low	2 × Bandgap – P2[6] (P2[6] = 1.3 V)	2.512 – P2[6]	2.602 – P2[6]	2.684 – P2[6]	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap + P2[6] (P2[6] = 1.3 V)	2.495 – P2[6]	2.586 – P2[6]	2.673 – P2[6]	V
		V _{AGND}	AGND	2 × Bandgap	2.528	2.601	2.668	V
		V _{REFLO}	Ref low	2 × Bandgap – P2[6] (P2[6] = 1.3 V)	2.510 – P2[6]	2.602 – P2[6]	2.685 – P2[6]	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap + P2[6] (P2[6] = 1.3 V)	2.498 – P2[6]	2.589 – P2[6]	2.674 – P2[6]	V
		V _{AGND}	AGND	2 × Bandgap	2.529	2.601	2.668	V
		V _{REFLO}	Ref low	2 × Bandgap – P2[6] (P2[6] = 1.3 V)	2.509 – P2[6]	2.601 – P2[6]	2.685 – P2[6]	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap + P2[6] (P2[6] = 1.3 V)	2.500 – P2[6]	2.591 – P2[6]	2.675 – P2[6]	V
		V _{AGND}	AGND	2 × Bandgap	2.530	2.603	2.669	V
		V _{REFLO}	Ref low	2 × Bandgap – P2[6] (P2[6] = 1.3 V)	2.508 – P2[6]	2.601 – P2[6]	2.686 – P2[6]	V

Table 35. 3.3-V DC Analog Reference Specifications (continued)

Reference ARF_CR [5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Units
0b101	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.226	P2[4] + 1.286	P2[4] + 1.343	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.323	P2[4] – 1.293	P2[4] – 1.262	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.232	P2[4] + 1.29	P2[4] + 1.344	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.324	P2[4] – 1.296	P2[4] – 1.267	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.233	P2[4] + 1.291	P2[4] + 1.345	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.324	P2[4] – 1.298	P2[4] – 1.269	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V _{DD} /2)	P2[4] + 1.234	P2[4] + 1.292	P2[4] + 1.345	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V _{DD} /2)	P2[4] – 1.324	P2[4] – 1.299	P2[4] – 1.270	V
0b110	RefPower = High Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap	2.504	2.595	2.672	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.006	V _{SS} + 0.013	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap	2.506	2.593	2.674	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.336	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.003	V _{SS} + 0.008	V
	RefPower = Medium Opamp bias = High	V _{REFHI}	Ref high	2 × Bandgap	2.506	2.594	2.675	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.335	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.002	V _{SS} + 0.007	V
	RefPower = Medium Opamp bias = Low	V _{REFHI}	Ref high	2 × Bandgap	2.507	2.595	2.675	V
		V _{AGND}	AGND	Bandgap	1.262	1.301	1.335	V
		V _{REFLO}	Ref low	V _{SS}	V _{SS}	V _{SS} + 0.001	V _{SS} + 0.005	V
0b111	All power settings. Not allowed for 3.3 V.	–	–	–	–	–	–	–

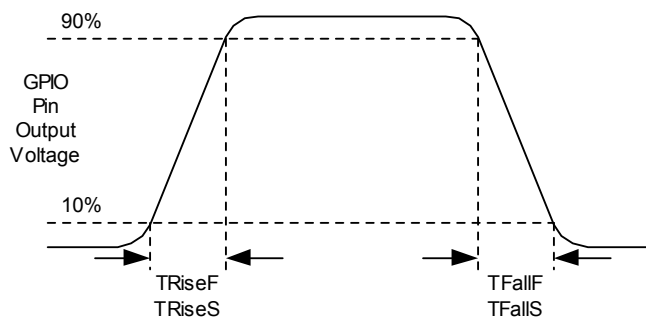
AC GPIO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 44. AC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F_{GPIO}	GPIO Operating Frequency	0	—	12.3	MHz	Normal Strong Mode
t_{RiseF}	Rise Time, Normal Strong Mode, Load = 50 pF	3	—	18	ns	$V_{\text{DD}} = 4.5$ to 5.25 V, 10% – 90%
t_{FallF}	Fall Time, Normal Strong Mode, Load = 50 pF	2	—	18	ns	$V_{\text{DD}} = 4.5$ to 5.25 V, 10% – 90%
t_{RiseS}	Rise Time, Slow Strong Mode, Load = 50 pF	10	27	—	ns	$V_{\text{DD}} = 3$ to 5.25 V, 10% – 90%
t_{FallS}	Fall Time, Slow Strong Mode, Load = 50 pF	10	22	—	ns	$V_{\text{DD}} = 3$ to 5.25 V, 10% – 90%

Figure 13. GPIO Timing Diagram



AC Programming Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 55. AC Programming Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
t_{RCLK}	Rise Time of SCLK	1	–	20	ns	
t_{FCLK}	Fall Time of SCLK	1	–	20	ns	
t_{SSCLK}	Data Setup Time to Falling Edge of SCLK	40	–	–	ns	
t_{HCLK}	Data Hold Time from Falling Edge of SCLK	40	–	–	ns	
F_{SCLK}	Frequency of SCLK	0	–	8	MHz	
t_{ERASEB}	Flash Erase Time (Block)	–	10	–	ms	
t_{WRITE}	Flash Block Write Time	–	40	–	ms	
t_{DSCLK}	Data Out Delay from Falling Edge of SCLK	–	–	55	ns	$V_{\text{DD}} > 3.6$
t_{DSCLK3}	Data Out Delay from Falling Edge of SCLK	–	–	75	ns	$3.0 \leq V_{\text{DD}} \leq 3.6$
t_{ERASEALL}	Flash Erase Time (Bulk)	–	40	–	ms	Erase all blocks and protection fields at once.
$t_{\text{PROGRAM_HOT}}$	Flash Block Erase + Flash Block Write Time	–	–	100 ^[30]	ms	$0^{\circ}\text{C} \leq T_j \leq 100^{\circ}\text{C}$
$t_{\text{PROGRAM_COLD}}$	Flash Block Erase + Flash Block Write Time	–	–	200 ^[30]	ms	$-40^{\circ}\text{C} \leq T_j \leq 0^{\circ}\text{C}$

Note

30. For the full industrial range, the user must employ a temperature sensor user module (FlashTemp) and feed the result to the temperature argument before writing. Refer to the Flash APIs Application Note, AN2015 at <http://www.cypress.com> under Application Notes for more information.

Development Tool Selection

This section presents the development tools available for all current PSoC device families including the CY8C28xxx family.

Software

PSoC Designer

At the core of the PSoC development software suite is PSoC Designer. Utilized by thousands of PSoC developers, this robust software has been facilitating PSoC designs for over half a decade. PSoC Designer is available free of charge at <http://www.cypress.com>.

PSoC Programmer

Flexible enough to be used on the bench in development, yet suitable for factory programming, PSoC Programmer works either as a standalone programming application or it can operate directly from PSoC Designer. PSoC Programmer software is compatible with both PSoC ICE-Cube In-Circuit Emulator and PSoC MiniProg. PSoC Programmer is available free of charge at <http://www.cypress.com>.

Development Kits

All development kits can be purchased from the Cypress Online Store.

CY3215-DK Basic Development Kit

The CY3215-DK is for prototyping and development with PSoC Designer. This kit supports in-circuit emulation and the software interface allows users to run, halt, and single step the processor and view the content of specific memory locations. Advanced emulation features are supported in PSoC Designer. The kit includes:

- PSoC Designer Software CD
- ICE-Cube In-Circuit Emulator
- Pod kit for CY8C29x66 PSoC Family
- Cat-5 Adapter
- Mini-Eval Programming Board
- 110 ~ 240 V Power Supply, Euro-Plug Adapter
- ISSP Cable
- USB 2.0 Cable and Blue Cat-5 Cable
- 2 CY8C29466-24PXI 28-PDIP Chip Samples

Evaluation Tools

All evaluation tools can be purchased from the Cypress Online Store.

CY3210-MiniProg1

The CY3210-MiniProg1 kit allows a user to program PSoC devices via the MiniProg1 programming unit. The MiniProg is a small, compact prototyping programmer that connects to the PC via a provided USB 2.0 cable. The kit includes:

- MiniProg Programming Unit
- MiniEval Socket Programming and Evaluation Board
- 28-Pin CY8C29466-24PXI PDIP PSoC Device Sample
- 28-Pin CY8C27443-24PXI PDIP PSoC Device Sample
- PSoC Designer Software CD
- Getting Started Guide
- USB 2.0 Cable

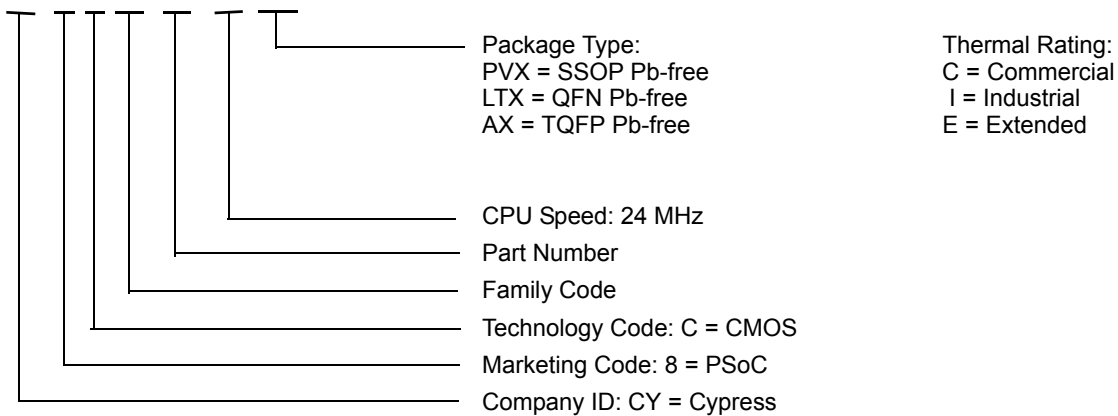
CY3210-PSoCEval1

The CY3210-PSoCEval1 kit features an evaluation board and the MiniProg1 programming unit. The evaluation board includes an LCD module, potentiometer, LEDs, and plenty of bread-boarding space to meet all of your evaluation needs. The kit includes:

- Evaluation Board with LCD Module
- MiniProg Programming Unit
- 28-Pin CY8C29466-24PXI PDIP PSoC Device Sample (2)
- PSoC Designer Software CD
- Getting Started Guide
- USB 2.0 Cable

Ordering Code Definitions

CY 8 C 28 xxx - SP xxxx



Glossary *(continued)*

shift register	A memory storage device that sequentially shifts a word either left or right to output a stream of serial data.
slave device	A device that allows another device to control the timing for data exchanges between two devices. Or when devices are cascaded in width, the slave device is the one that allows another device to control the timing of data exchanges between the cascaded devices and an external interface. The controlling device is called the master device.
SRAM	An acronym for static random access memory. A memory device allowing users to store and retrieve data at a high rate of speed. The term static is used because, after a value has been loaded into an SRAM cell, it remains unchanged until it is explicitly altered or until power is removed from the device.
SROM	An acronym for supervisory read only memory. The SROM holds code that is used to boot the device, calibrate circuitry, and perform Flash operations. The functions of the SROM may be accessed in normal user code, operating from Flash.
stop bit	A signal following a character or block that prepares the receiving device to receive the next character or block.
synchronous	1. A signal whose data is not acknowledged or acted upon until the next active edge of a clock signal. 2. A system whose operation is synchronized by a clock signal.
tri-state	A function whose output can adopt three states: 0, 1, and Z (high-impedance). The function does not drive any value in the Z state and, in many respects, may be considered to be disconnected from the rest of the circuit, allowing another output to drive the same net.
UART	A UART or universal asynchronous receiver-transmitter translates between parallel bits of data and serial bits.
user modules	Pre-build, pre-tested hardware/firmware peripheral functions that take care of managing and configuring the lower level Analog and Digital PSoC Blocks. User Modules also provide high level API (Application Programming Interface) for the peripheral function.
user space	The bank 0 space of the register map. The registers in this bank are more likely to be modified during normal program execution and not just during initialization. Registers in bank 1 are most likely to be modified only during the initialization phase of the program.
V _{DD}	A name for a power net meaning “voltage drain.” The most positive power supply signal. Usually 5 V or 3.3 V.
V _{SS}	A name for a power net meaning “voltage source.” The most negative power supply signal.
watchdog timer	A timer that must be serviced periodically. If it is not serviced, the CPU resets after a specified period of time.

Document History Page

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Revision	ECN	Origin of Change	Submission Date	Description of Change
**	2593460	BTK / PYRS	10/20/08	New document (Revision **).
*A	2652217	BTK / PYRS	02/02/09	Extensive updates to content. Added registers maps. Updated Getting Started section Updated Development Tools section Added some SAR10 ADC specifications. Added more analog system figures
*B	2675937	BTK	03/18/09	Updated DC Analog Reference Specifications tables Minor content updates
*C	2679015	HMI	03/26/2009	Post to external web.
*D	2750217	TDU	08/10/09	Updates to Electrical Specifications section Minor content updates
*E	2768143	TDU	09/23/09	Updated DC Operational Amplifier, DC Analog Reference, DC SAR10ADC, and DC POR specifications; Added Figure 15 and Figure 16; Updated AC TypeE-Operational and AC SAR10ADC specifications
*F	2805324	ALH	11/11/09	Added Contents page. Updated Electrical Specifications .
*G	2902396	NJF	03/30/2010	Updated Cypress website links. Added T _{BAKETEMP} and T _{BAKETIME} parameters in Absolute Maximum Ratings . Updated DC SAR10 ADC Specifications . Modified Note 23. Removed AC Analog Mux Bus Specifications, Third Party Tools and Build a PSoC Emulator into your Board. Updated Packaging Information and Ordering Code Definitions . Updated links in Sales , Solutions , and Legal Information .
*H	3063584	NJF	10/20/10	Added PSoC Device Characteristics table. Added DC I2C Specifications table. Added F32K _U max limit. Added Tjit_IMO specification, removed existing jitter specifications. Updated Analog reference tables. Updated Units of Measure, Acronyms, Glossary, and References sections. Updated solder reflow specifications. No specific changes were made to AC Digital Block Specifications table and I2C Timing Diagram. They were updated for clearer understanding. Updated Figure 13 since the labelling for y-axis was incorrect. Template and styles update.
*I	3148779	NJF	01/20/11	Added Footnote # 34 to Thermal Impedances section. Table 7. 56-Pin Part Pinout (SSOP) (page 15) - Pin#28 - Pin Name changed to "V _{SS} ". Table 5. 44-Pin Part Pinout (TQFP) (page 13) - Pin#17 - Pin Type changed to "Power". Under DC SAR10 ADC Specifications table, for parameter V _{VREFSAR10} , Max value changed from 4.95 V to V _{DD} - 0.3 V. Updated Table 59, "Solder Reflow Specifications," on page 72 as per spec 25-00090.
*J	3598237	LURE / XZNG	04/24/2012	Changed the PWM description string from "8- to 32-bit" to "8- and 16-bit".
*K	3758002	GULA	10/01/2012	Updated Packaging Information (spec 001-45616 (Changed revision from *B to *D), spec 51-85062 (Changed revision from *D to *F)).